# DISCRETE SEMICONDUCTORS





BAS321
General purpose diode

Product specification
Supersedes data of 1999 Feb 09

2004 Jan 26







# General purpose diode

**BAS321** 

# **FEATURES**

- Small plastic SMD package
- Switching speed: max. 50 ns
- · General application
- Continuous reverse voltage: max. 200 V
- Repetitive peak reverse voltage: max. 250 V
- Repetitive peak forward current: max. 625 mA.

### **APPLICATIONS**

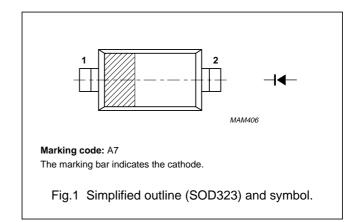
• General purpose switching in e.g. surface mounted circuits.

### **DESCRIPTION**

The BAS321 is a general purpose diode fabricated in planar technology and encapsulated in a plastic SOD323 package.

### **PINNING**

PIN	DESCRIPTION
1	cathode
2	anode



### **ORDERING INFORMATION**

TYPE	PACKAGE					
NUMBER	NAME	DESCRIPTION VER				
BAS321	_	plastic surface mounted package; 2 leads				

# **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>RRM</sub>	repetitive peak reverse voltage		_	250	V
V <sub>R</sub>	continuous reverse voltage		_	200	V
I <sub>F</sub>	continuous forward current	see Fig.2; note 1	_	250	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p < 0.5 \text{ ms}; \delta \le 0.25$	_	625	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; T <sub>j</sub> = 25 °C prior to surge; see Fig.4			
		t = 1 μs	_	9	Α
		t = 100 μs	_	3	Α
		t = 10 ms	_	1.7	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C; note 1	_	300	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

### Note

1. Device mounted on an FR4 printed circuit-board.

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# **CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V <sub>F</sub>	forward voltage	see Fig.3		
		I <sub>F</sub> = 100 mA	1	V
		I <sub>F</sub> = 200 mA	1.25	V
I <sub>R</sub>	reverse current	see Fig.5		
		V <sub>R</sub> = 200 V	100	nA
		V <sub>R</sub> = 200 V; T <sub>j</sub> = 150 °C	100	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0; see Fig.6	2	pF
t <sub>rr</sub>	reverse recovery time	when switched from $I_F$ = 30 mA to $I_R$ = 30 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA; see Fig.8	50	ns

# THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point	T <sub>s</sub> = 90°C; note 1	130	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 2	366	K/W

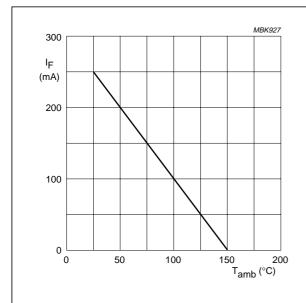
# Notes

- 1. Soldering point of cathode tab.
- 2. Device mounted on an FR4 printed circuit board.

# General purpose diode

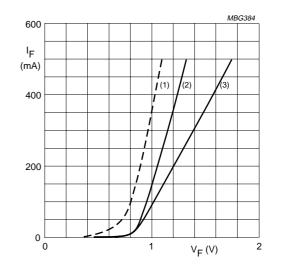
**BAS321** 

# **GRAPHICAL DATA**



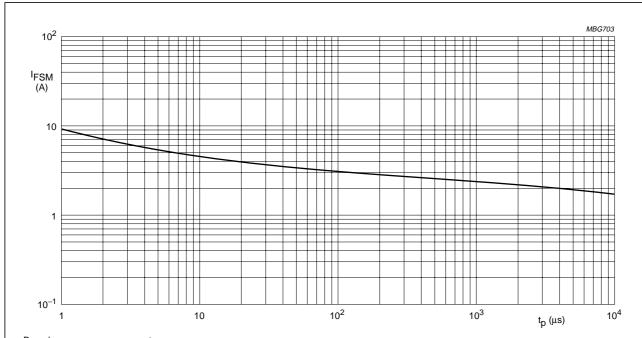
Device mounted on an FR4 printed-circuit board.

Fig.2 Maximum permissible continuous forward current as a function of ambient temperature.



- (1)  $T_j = 150$  °C; typical values.
- (2)  $T_j = 25$  °C; typical values.
- (3)  $T_j = 25$  °C; maximum values.

Fig.3 Forward current as a function of forward voltage.



Based on square wave currents.

 $T_j$  = 25 °C prior to surge.

Fig.4 Maximum permissible non-repetitive peak forward current as a function of pulse duration.

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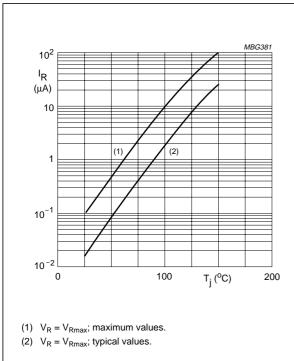
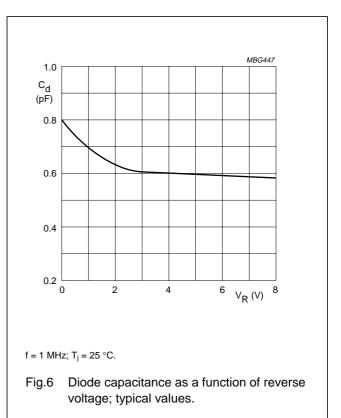


Fig.5 Reverse current as a function of junction temperature.



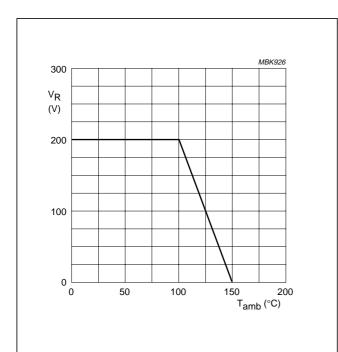
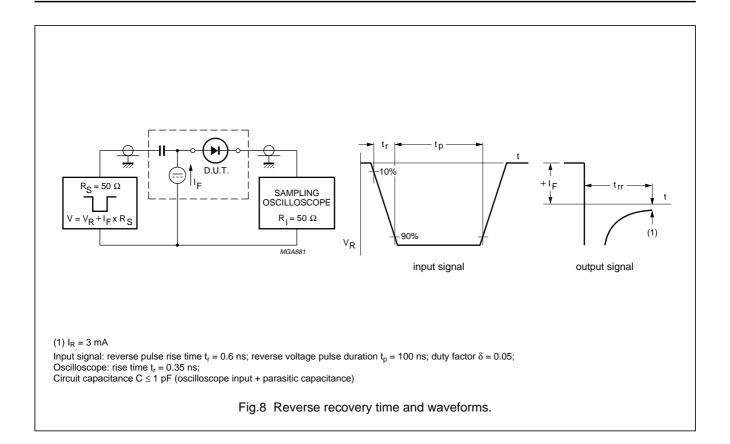


Fig.7 Maximum permissible continuous reverse voltage as a function of the ambient temperature.

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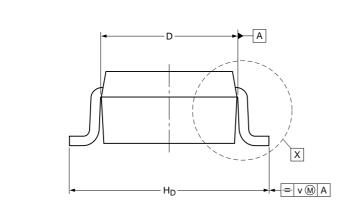
# General purpose diode

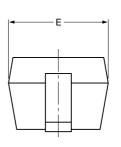
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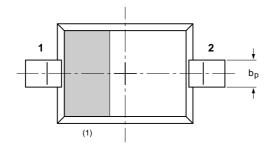
# **PACKAGE OUTLINE**

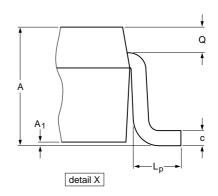
Plastic surface mounted package; 2 leads

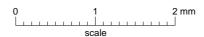
SOD323











# DIMENSIONS (mm are the original dimensions)

UNIT	Α	A <sub>1</sub> max	bp	С	D	E	H <sub>D</sub>	Lp	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

#### Note

1. The marking bar indicates the cathode

OUTLINE		REFERENCES			ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOD323			SC-76			<del>99-09-13</del> 03-12-17

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#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R76/02/pp9

Date of release: 2004 Jan 26

Document order number: 9397 750 12589

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